IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

MAIL STOP PATENT APPLICATION Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

CERTIFICATE UNDER 37 CFR 1.1	0

I hereby certify that this correspondence and the documents referred to as attached therein are being deposited on with the United States Postal Service in an envelope as "Express Mail Post Office to Addressee," mailing label No. EV335471051US addressed to: Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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Invent	or(s):	LING CHEN	AND MEI CHANG				
Title:		ENHANCEMENT OF CU LINE RELIABILITY USING THIN ALD TAN FITTO CAP THE CU LINE					
Transi	mitted herewith	is the patent app	lication identified	above, including:			
\boxtimes	Specification	, claims and abst	ract	24 Total Pages			
\boxtimes	Drawings		☐ Informal	5 Total Pages			
\boxtimes	Un-Executed Declaration and Power of Attorney						
	Information Disclosure Statement with List						
	Assignment of the Invention to Applied Materials, Inc.						
	Assignment Recordation Cover Sheet						

FEE CALCULATION

	NUMBER OF CLAIMS FILED	LESS NUMBER PAID BY BASIC FEE	NUMBER OF EXTRA CLAIMS (Not less than zero)	LARGE ENTITY FEE
Basic Fee				\$770.00
Total Claims	26	- 20 = 6	X \$18 =	\$ 108.00
Independent Claims	3	- 3 =	X \$86 =	\$ 0.00
First Presentation of Multiple Dependent Claims + \$00				-0-
Total Filing Fee Calculation				\$ 878.00

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	The Commissioner is hereby authorized to cha duplicate copy of this transmittal is enclose		00 to Deposit Account No
	The Commissioner is hereby authorized to cha required, or credit any overpayment to Deposit this transmittal is enclosed.		
\boxtimes	Please address all future correspondence to:	\boxtimes	Please direct all telephone calls to:
	PATENT COUNSEL APPLIED MATERIALS, INC. Legal Affairs Department P.O. Box 450A		B. Todd Patterson 713-623-4844

Respectfully submitted,

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